

**Sensitive Gate Triacs  
Silicon Bidirectional Thyristors**

**TRIACS  
16 AMPERES RMS  
600 VOLTS**

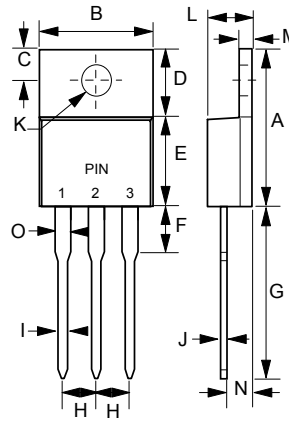
**FEATURES**

- Sensitive Gate allows Triggering by Microcontrollers and other
- Maximum Values of IGT, VGT and IH Specified for Ease of Design
- On-State Current Rating of 15 A RMS at 70°C
- High Surge Current Capability - 120 A
- Blocking Voltage to 800 V
- Uniform Gate Trigger Currents in Three Quadrants, Q1, Q2, and Q3
- Pb Free Package

**MECHANICAL DATA**

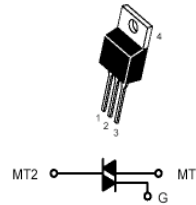
- Case: Molded plastic
- Weight: 0.07 ounces, 2.0 grams

**TO-220AB**



TO-220AB		
DIM.	MIN.	MAX.
A	14.22	15.88
B	9.65	10.67
C	2.54	3.43
D	5.84	6.86
E	8.26	9.28
F	-	6.35
G	12.70	14.73
H	2.29	2.79
I	0.51	1.14
J	0.40	0.67
K	3.53 $\phi$	4.09 $\phi$
L	3.56	4.83
M	1.14	1.40
N	2.03	2.92
O	1.17	1.37

All Dimensions in millimeter



PIN ASSIGNMENT	
1	Main Terminal 1
2	Main Terminal 2
3	Gate
4	Main Terminal 2

**MAXIMUM RATINGS** (T<sub>j</sub>= 25°C unless otherwise noticed)

Rating	Symbol	Value	Unit
Peak Repetitive Off- State Voltage (1) (T <sub>J</sub> = -40 to 110°C, Sine Wave, 50 to 60 Hz; Gate Open)	V <sub>DRM</sub> , V <sub>RRM</sub>	600	Volts
On-State RMS Current (T <sub>c</sub> = +70°C) Full Cycle Sine Wave 50 to 60 Hz	I <sub>T(RMS)</sub>	16	Amp
Peak Non-Repetitive Surge Current (One Full Cycle Sine Wave, 60 Hz, T <sub>J</sub> = +25°C) Preceded and followed by rated current.	I <sub>TSM</sub>	120	Amps
Circuit Fusing Consideration (t = 8.3 ms)	I <sup>2</sup> t	93	A <sup>2</sup> s
Peak Gate Power (T <sub>c</sub> = +70°C, T <sub>p</sub> ≤ 1.0 us)	P <sub>GM</sub>	20	Watt
Average Gate Power (T <sub>c</sub> = +70°C, t=8.3 ms)	P <sub>G(AV)</sub>	0.5	Watt
Operating Junction Temperature Range	T <sub>J</sub>	-40 to +110	°C
Storage Temperature Range	T <sub>stg</sub>	-40 to +150	°C

Notice: (1) V<sub>DRM</sub> and V<sub>RRM</sub> for all types can be applied on a continuous basis. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

REV. 5, Dec-2010,KTXC22

**THERMAL CHARACTERISTICS**

Characteristic	Symbol	Value	Unit
Thermal Resistance - Junction to Case - Junction to Ambient	R <sub>thJC</sub> R <sub>thJA</sub>	2.0 62.5	°C/W
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds	TL	260	°C

**ELECTRICAL CHARACTERISTICS** (T<sub>c</sub>=25°C unless otherwise noted, Electrical apply in both directions)

Characteristics	Symbol	Min	Typ	Max	Unit
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**OFF CHARACTERISTICS**

Peak Repetitive Forward or Reverse Blocking Current (V <sub>D</sub> =Rated V <sub>DRM</sub> , V <sub>RRM</sub> ; Gate Open)	T <sub>J</sub> =25°C T <sub>J</sub> =110°C	I <sub>DRM</sub> I <sub>RRM</sub>	---- ----	---- ----	0.01 2.0	mA
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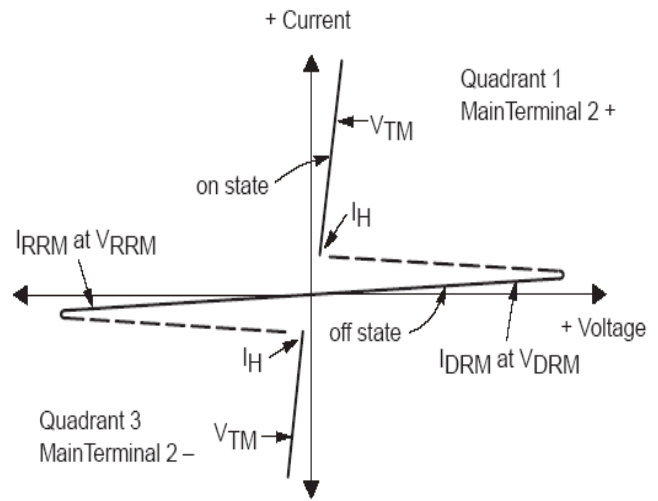
**ON CHARACTERISTICS**

Peak On-State Voltage (I <sub>TM</sub> =± 21 A Peak @T <sub>p</sub> ≤ 2.0 ms, Duty Cycle ≤ 2%)	V <sub>TM</sub>	----	----	1.8	Volts
Gate Trigger Current (V <sub>D</sub> = 12Vdc; R <sub>L</sub> = 100 Ohms)	I <sub>GT1</sub> I <sub>GT2</sub> I <sub>GT3</sub>	---- ---- ----	2.0 3.0 3.0	5.0 5.0 5.0	mA
Gate Trigger Voltage (V <sub>D</sub> = 12 Vdc; R <sub>L</sub> =100 Ohms)	V <sub>GT1</sub> V <sub>GT2</sub> V <sub>GT3</sub>	0.45 0.45 0.45	0.62 0.60 0.65	1.5 1.5 1.5	Volts
Holding Current (V <sub>D</sub> = 12 V, Initiating Current = ± 150 mA, Gate Open)	I <sub>H</sub>	----	3.0	10	mA
Latching Current (V <sub>D</sub> = 24 V, I <sub>G</sub> = 50 mA)	I <sub>L</sub>	---- ---- ----	5.0 10 5.0	15 20 15	mA

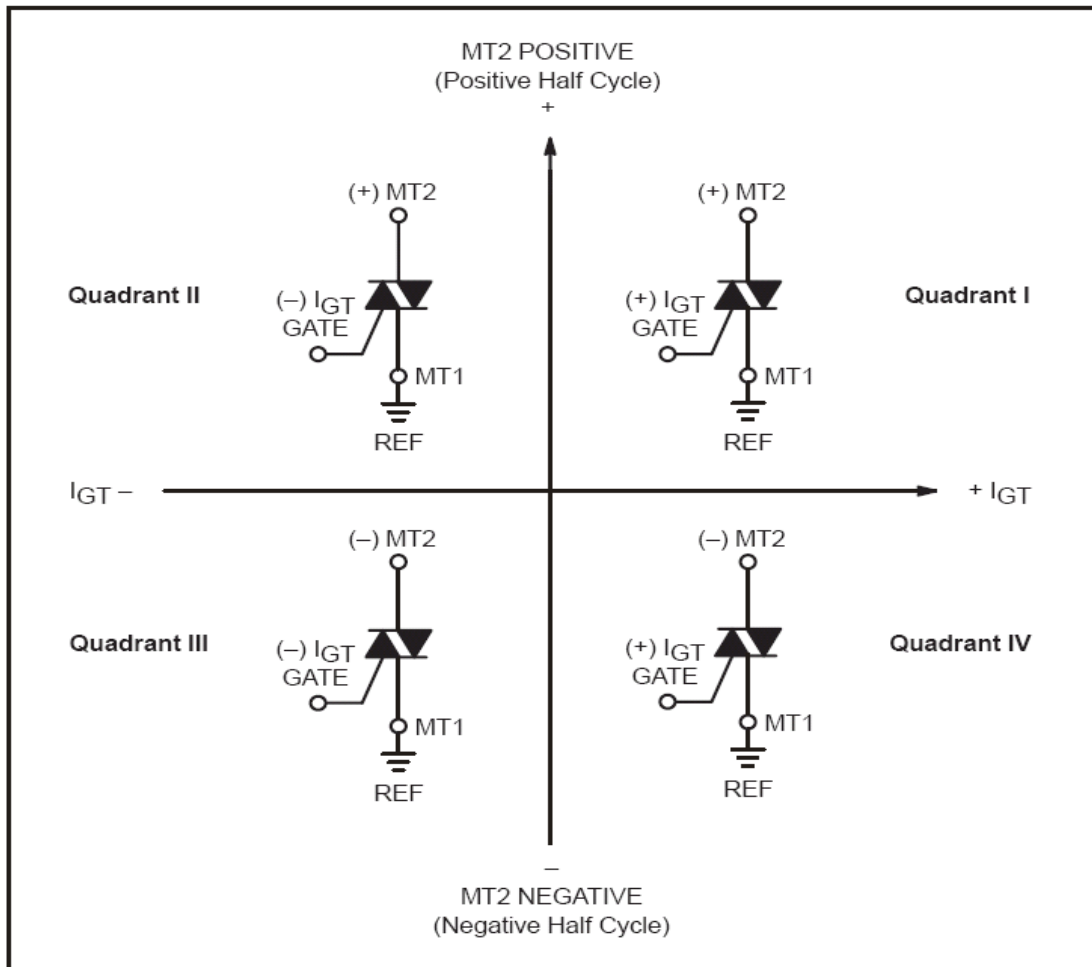
**DYNAMIC CHARACTERISTICS**

Critical Rate of Change of Commutation Current (V <sub>D</sub> = Rated V <sub>DRM</sub> , I <sub>TM</sub> = 3.5 A, Commutating dv/dt = 10 V/us, Gate Unenergized, T <sub>c</sub> = 110°C, f = 250 Hz, Snubber: C <sub>s</sub> = 0.01 uf, R <sub>s</sub> =15 Ohms)	di/dt(c)	8.0	10	----	A/ms
Critical Rate of Rise of Commutation Voltage (V <sub>D</sub> = 67% V <sub>DRM</sub> , Exponential Waveform, R <sub>GK</sub> = 510 Ohms, T <sub>c</sub> = 110°C)	dv/dt	25	75	----	V/us

Symbol	Parameter
$V_{DRM}$	Peak Repetitive Forward Off State Voltage
$I_{DRM}$	Peak Forward Blocking Current
$V_{RRM}$	Peak Repetitive Reverse Off State Voltage
$I_{RRM}$	Peak Reverse Blocking Current
$V_{TM}$	Maximum On State Voltage
$I_H$	Holding Current

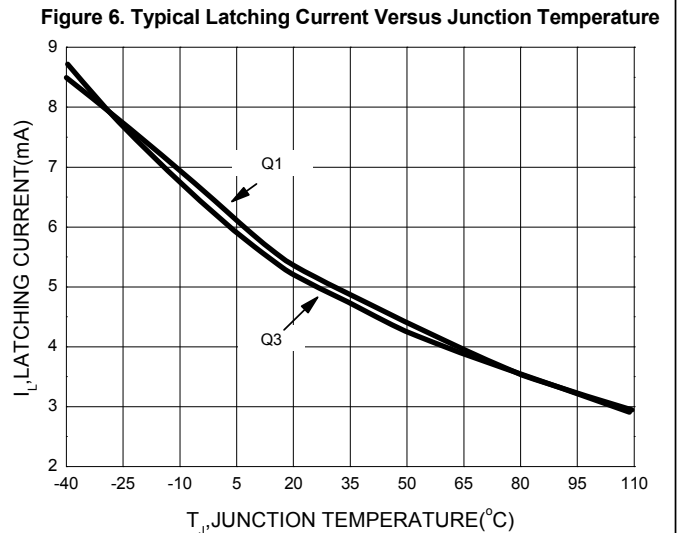
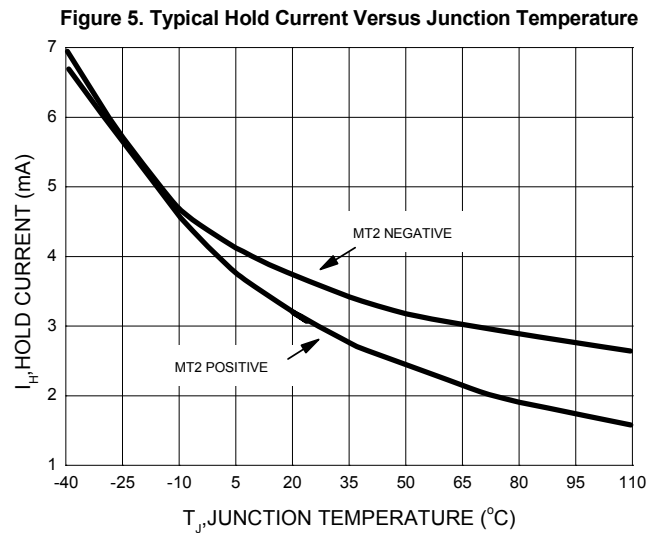
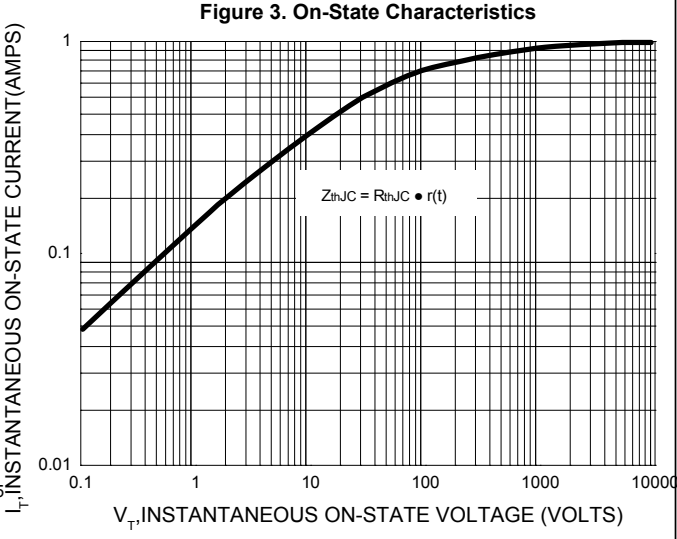
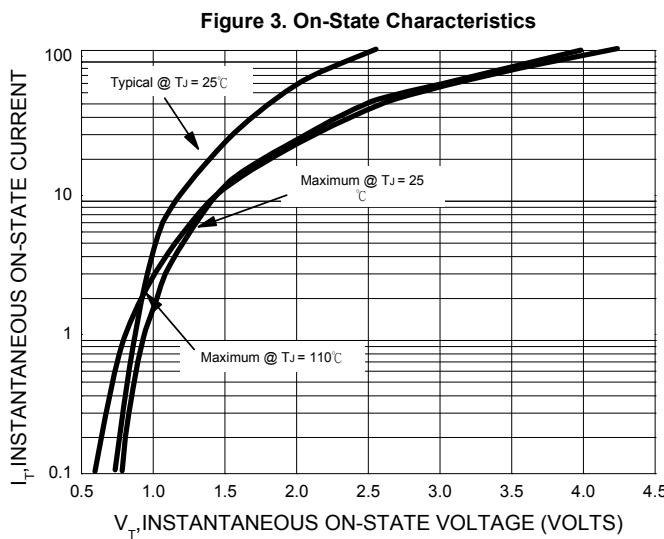
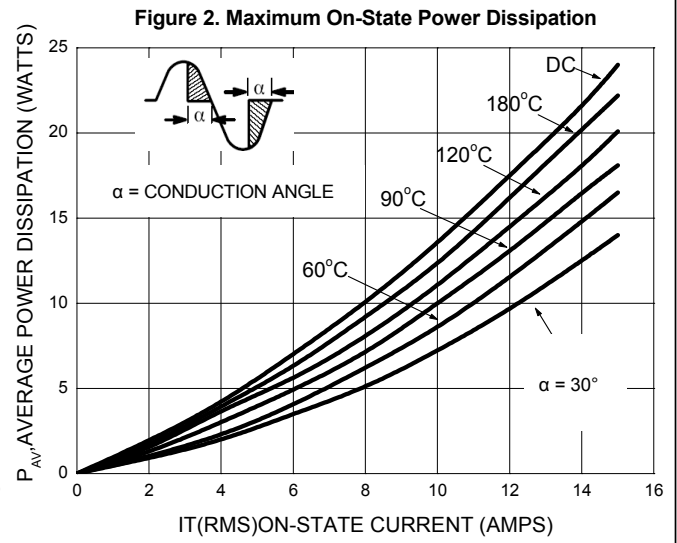
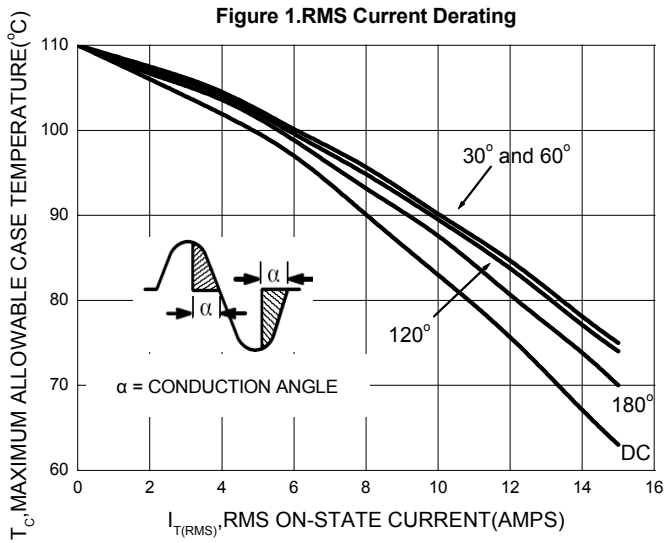


### Quadrant Definitions

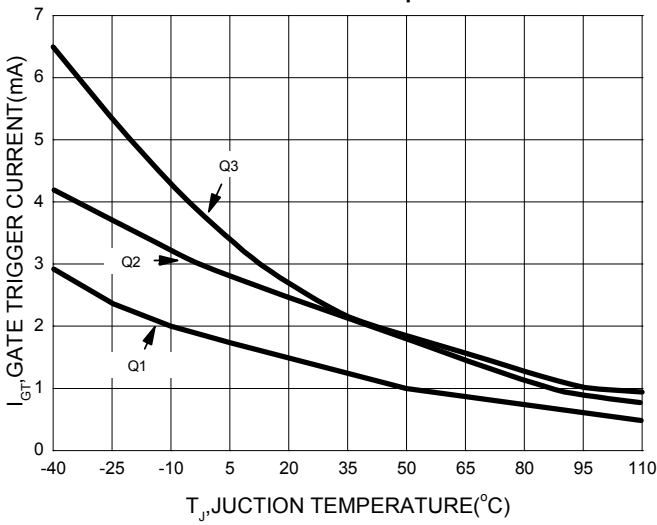


All polarities are referenced to MT1

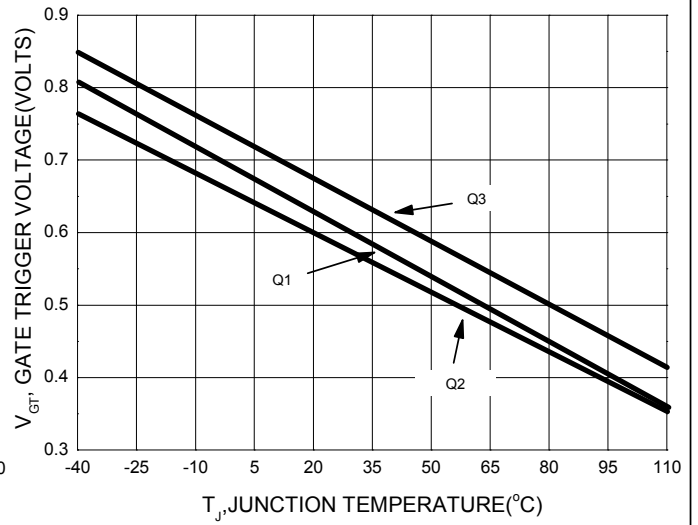
Whith in -phase signal (using standard AC lines) quadrants I and III are used



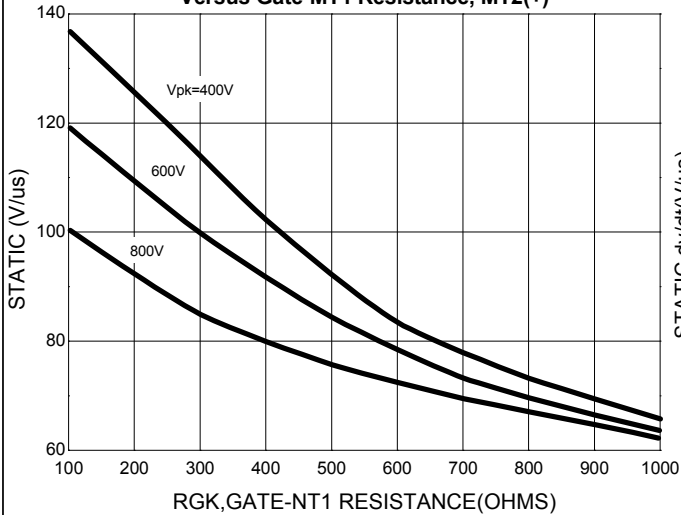
**Figure 7. Typical Gate Trigger Current Versus Junction Temperature**



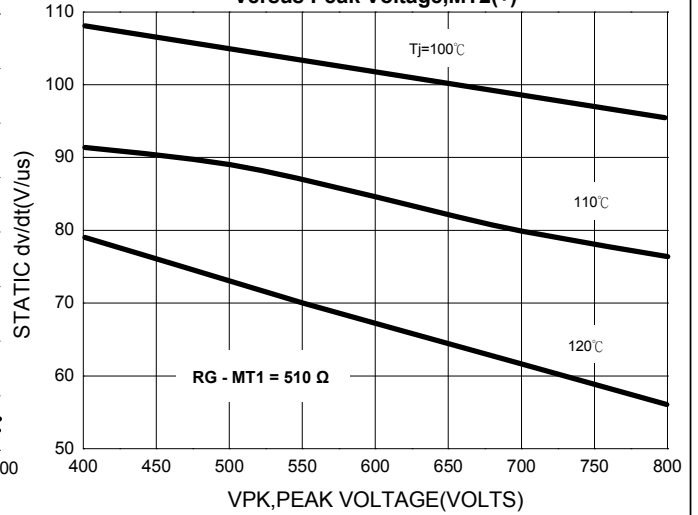
**Figure 8. Typical Gate Trigger Voltage Versus Junction Temperature**



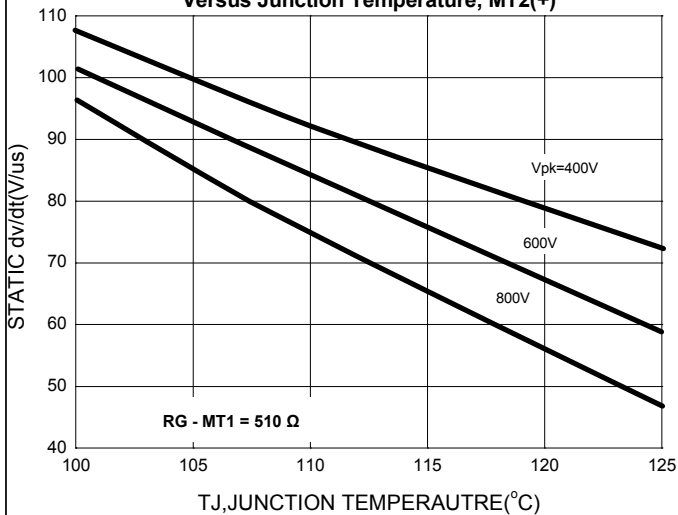
**Figure 9. Typical Exponential Static dv/dt Versus Gate-MT1 Resistance, MT2(+)**



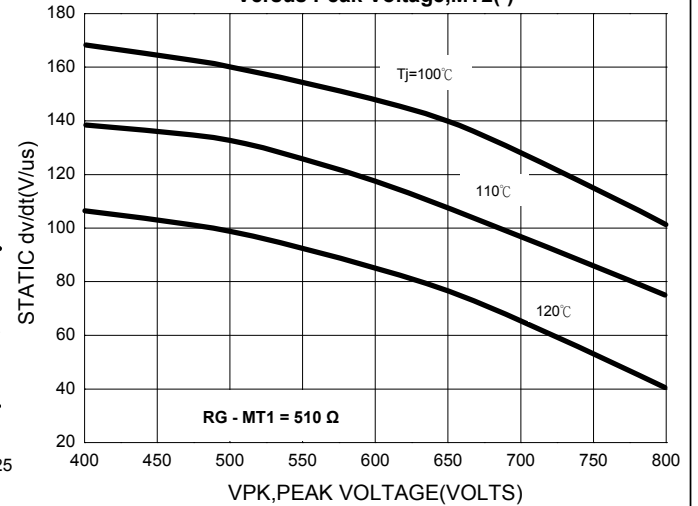
**Figure 10. Typical Exponential Static dv/dt Versus Peak Voltage, MT2(+)**



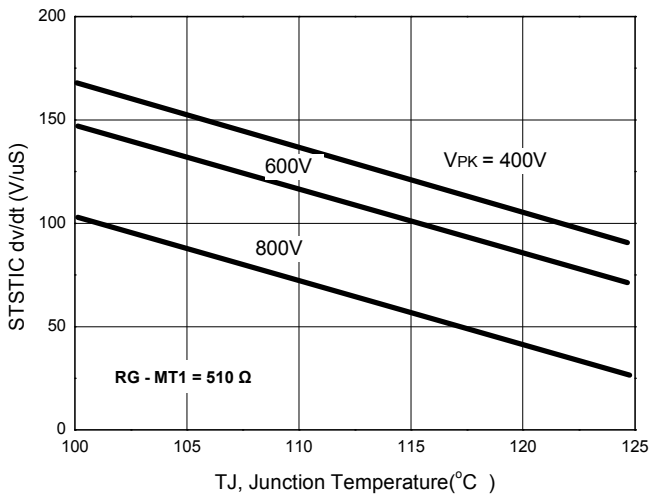
**Figure 11. Typical Exponential Static dv/dt Versus Junction Temperature, MT2(+)**



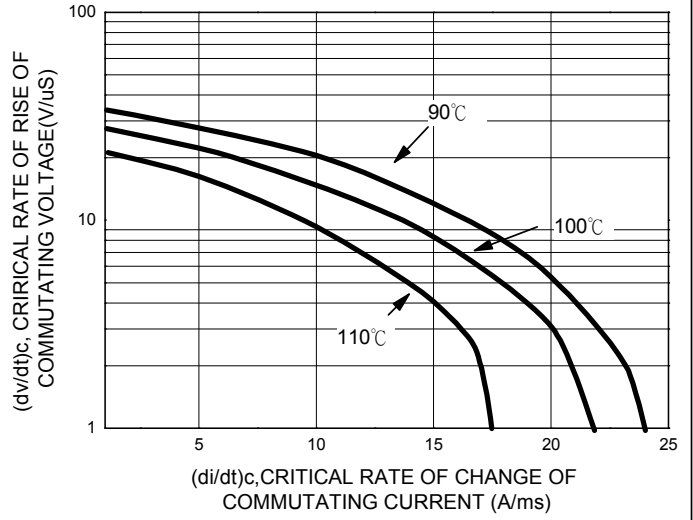
**Figure 12. Typical Exponential Static dv/dt Versus Peak Voltage, MT2(-)**



**Figure 13. Typical Exponential Static dv/dt Versus Junction Temperature, MT2(-)**



**Figure 14. Critical Rate of Rise of Commutating Voltage**



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